



BTA08, BTB08 T810, T835

Snubberless™, logic level and standard 8 A Triacs

Features

- On-state rms current, $I_{T(RMS)}$ 8 A
- Repetitive peak off-state voltage, V_{DRM}/V_{RRM} 600 to 800 V
- Triggering gate current, $I_{GT(Q1)}$ 5 to 50 mA

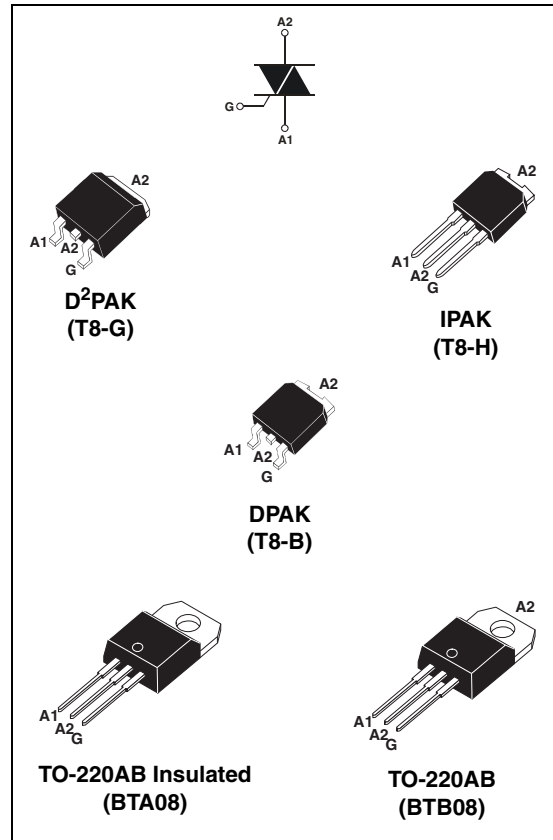
Description

Available either in through-hole or surface-mount packages, the **BTA08**, **BTB08** and **T8** triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers,...

The snubberless versions (BTA/BTB...W and T8 series) are specially recommended for use on inductive loads, thanks to their high commutation performances.

Logic level versions are designed to interface directly with low power drivers such as microcontrollers.

By using an internal ceramic pad, the BTA series provides voltage insulated tab (rated at 2500 V_{RMS}) complying with UL standards (file ref.: E81734).



1 Characteristics

Table 1. Absolute maximum ratings

| Symbol | Parameter | | Value | Unit | |
|--------------------|---|---|-----------------------|--------------------------------|------------------|
| $I_{T(RMS)}$ | On-state rms current (full sine wave) | IPAK/D ² PAK/DPAK/ TO-220AB | $T_c = 110\text{ °C}$ | 8 | A |
| | | TO-220AB Ins. | $T_c = 100\text{ °C}$ | | |
| I_{TSM} | Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C) | F = 50 Hz | t = 20 ms | 80 | A |
| | | F = 60 Hz | t = 16.7 ms | 84 | |
| I_t^2 | I_t^2 value for fusing | $t_p = 10\text{ ms}$ | | 36 | A ² s |
| dI/dt | Critical rate of rise of on-state current $I_G = 2$ x I_{GT} , $t_r \leq 100\text{ ns}$ | F = 120 Hz | $T_j = 125\text{ °C}$ | 50 | A/ μ s |
| I_{GM} | Peak gate current | $t_p = 20\text{ }\mu$ s | $T_j = 125\text{ °C}$ | 4 | A |
| $P_{G(AV)}$ | Average gate power dissipation | | $T_j = 125\text{ °C}$ | 1 | W |
| T_{stg} T_j | Storage junction temperature range Operating junction temperature range | | | - 40 to + 150 - 40 to + 125 | °C |

**Table 2. Electrical characteristics ($T_j = 25\text{ °C}$, unless otherwise specified)
Snubberless and logic level (3 quadrants)**

| Symbol | Test conditions | Quadrant | | T8 | | BTA08 / BTB08 | | | | Unit |
|-------------------------------------|---|--------------|------|------|------|---------------|------|-----|------|------------|
| | | | | T810 | T835 | TW | SW | CW | BW | |
| $I_{GT}^{(1)}$ | $V_D = 12\text{ V}$ $R_L = 30\text{ }\Omega$ | I - II - III | MAX. | 10 | 35 | 5 | 10 | 35 | 50 | mA |
| V_{GT} | | I - II - III | MAX. | 1.3 | | | | | | V |
| V_{GD} | $V_D = V_{DRM}$ $R_L = 3.3\text{ k}\Omega$ $T_j = 125\text{ °C}$ | I - II - III | MIN. | 0.2 | | | | | | V |
| $I_H^{(2)}$ | $I_T = 100\text{ mA}$ | | MAX. | 15 | 35 | 10 | 15 | 35 | 50 | mA |
| I_L | $I_G = 1.2 I_{GT}$ | I - III | MAX. | 25 | 50 | 10 | 25 | 50 | 70 | mA |
| | | II | | 30 | 60 | 15 | 30 | 60 | 80 | |
| dV/dt ⁽²⁾ | $V_D = 67\% V_{DRM}$ gate open $T_j = 125\text{ °C}$ | | MIN. | 40 | 400 | 20 | 40 | 400 | 1000 | V/ μ s |
| (dI/dt) _c ⁽²⁾ | (dV/dt) _c = 0.1 V/ μ s $T_j = 125\text{ °C}$ | | MIN. | 5.4 | - | 3.5 | 5.4 | - | - | A/ms |
| | (dV/dt) _c = 10 V/ μ s $T_j = 125\text{ °C}$ | | | 2.8 | - | 1.5 | 2.98 | - | - | |
| | Without snubber $T_j = 125\text{ °C}$ | | | - | 4.5 | - | - | 4.5 | 7 | |

Table 3. Standard (4 quadrants)

| Symbol | Test conditions | Quadrant | | BTA08 / BTB08 | | Unit |
|-------------------|--|-----------------------------------|------|---------------|-----------|------------------|
| | | | | C | B | |
| $I_{GT}^{(1)}$ | $V_D = 12\text{ V}, R_L = 33\ \Omega$ | I - II - III IV | MAX. | 25 50 | 50 100 | mA |
| V_{GT} | | ALL | MAX. | 1.3 | | V |
| V_{GD} | $V_D = V_{DRM}, R_L = 3.3\text{ k}\Omega, T_j = 125\text{ }^\circ\text{C}$ | ALL | MIN. | 0.2 | | V |
| $I_H^{(2)}$ | $I_T = 500\text{ mA}$ | | MAX. | 25 | 50 | mA |
| I_L | $I_G = 1.2 I_{GT}$ | I - III - IV | MAX. | 40 | 50 | mA |
| | | II | | 80 | 100 | |
| $dV/dt^{(2)}$ | $V_D = 67\% V_{DRM}$ gate open | $T_j = 125\text{ }^\circ\text{C}$ | MIN. | 200 | 400 | V/ μs |
| $(dV/dt)_c^{(2)}$ | $(dI/dt)_c = 5.3\text{ A/ms}$ | $T_j = 125\text{ }^\circ\text{C}$ | MIN. | 5 | 10 | V/ μs |

Table 4. Static characteristics

| Symbol | Test conditions | | | Value | Unit |
|------------------------|--|-----------------------------------|------|-------|---------------|
| $V_{TM}^{(1)}$ | $I_{TM} = 11\text{ A}, t_p = 380\ \mu\text{s}$ | $T_j = 25\text{ }^\circ\text{C}$ | MAX. | 1.55 | V |
| $V_{I0}^{(2)}$ | Threshold voltage | $T_j = 125\text{ }^\circ\text{C}$ | MAX. | 0.85 | V |
| $R_d^{(2)}$ | Dynamic resistance | $T_j = 125\text{ }^\circ\text{C}$ | MAX. | 50 | m Ω |
| I_{DRM} I_{RRM} | $V_{DRM} = V_{RRM}$ | $T_j = 25\text{ }^\circ\text{C}$ | MAX. | 5 | μA |
| | | $T_j = 125\text{ }^\circ\text{C}$ | | 1 | mA |

1. minimum I_{GT} is guaranteed at 5% of I_{GT} max.

2. for both polarities of A2 referenced to A1.

Table 5. Thermal resistance

| Symbol | Parameter | | Value | Unit | |
|---------------|-----------------------|-----------------------|---|------|--------------------|
| $R_{th(j-c)}$ | Junction to case (AC) | | IPAK / D ² PAK / DPAK / TO-220AB | 1.6 | $^\circ\text{C/W}$ |
| | | | TO-220AB Insulated | 2.5 | |
| $R_{th(j-a)}$ | Junction to ambient | $S = 1\text{ cm}^2$ | D ² PAK | 45 | $^\circ\text{C/W}$ |
| | | $S = 0.5\text{ cm}^2$ | DPAK | 70 | |
| | | | TO-220AB / TO-220AB Insulated | 60 | |
| | | | IPAK | 100 | |

S = Copper surface under tab.

Figure 1. Maximum power dissipation versus rms on-state current (full cycle)

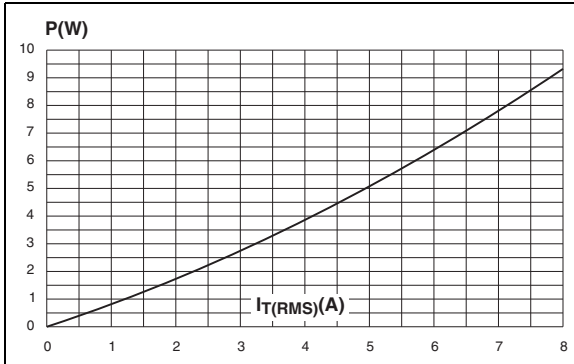


Figure 2. On-state rms current versus case temperature (full cycle)

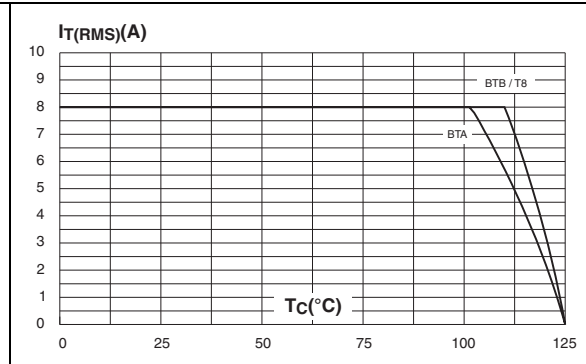


Figure 3. On-state rms current versus ambient temperature (full cycle)

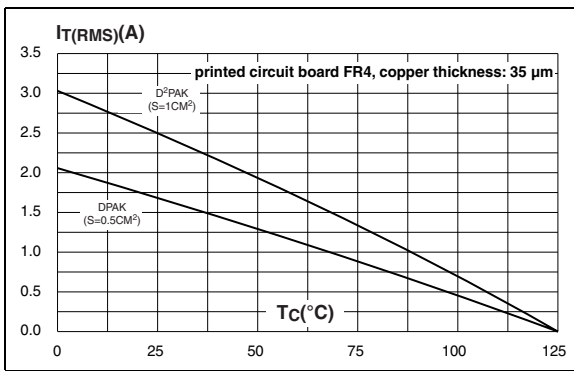


Figure 4. Relative variation of thermal impedance versus pulse duration

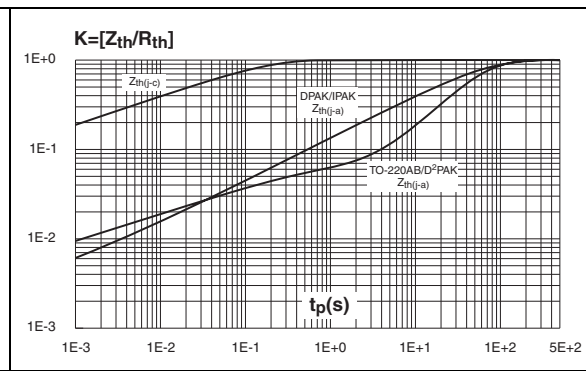


Figure 5. On-state characteristics (maximum values)

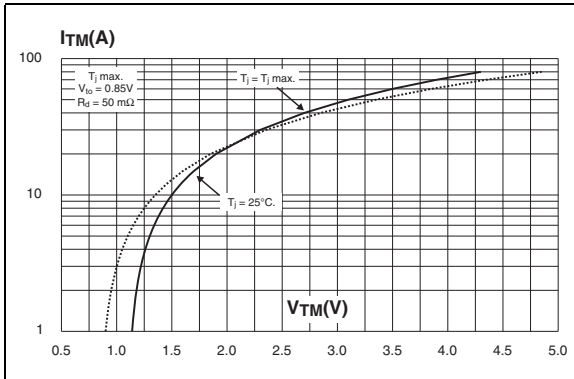


Figure 6. Surge peak on-state current versus number of cycles

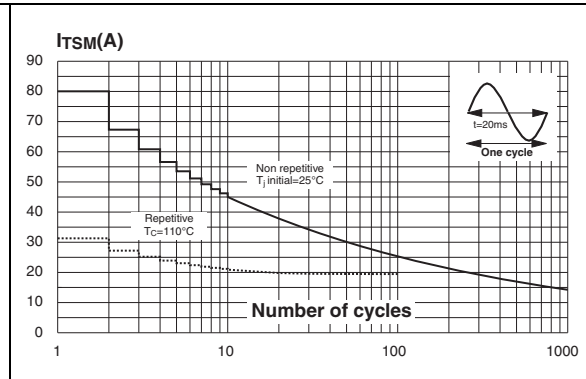


Figure 7. Non-repetitive surge peak on-state current for a sinusoidal

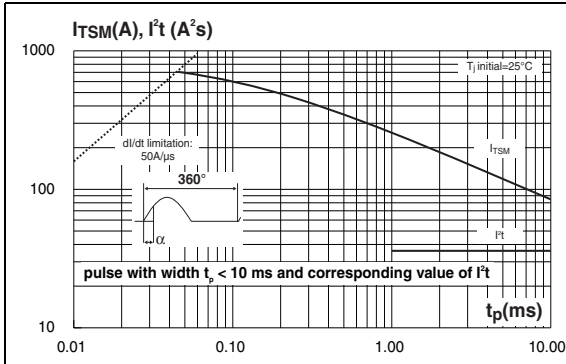


Figure 8. Relative variation of gate trigger current

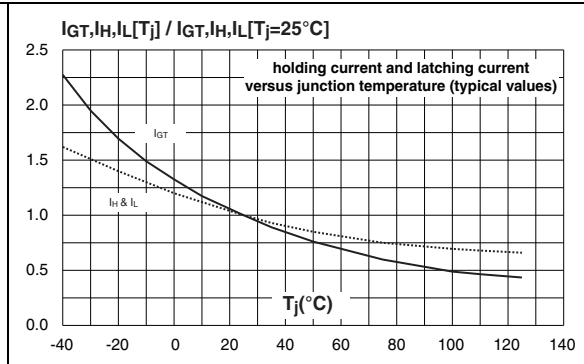


Figure 9. Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values)

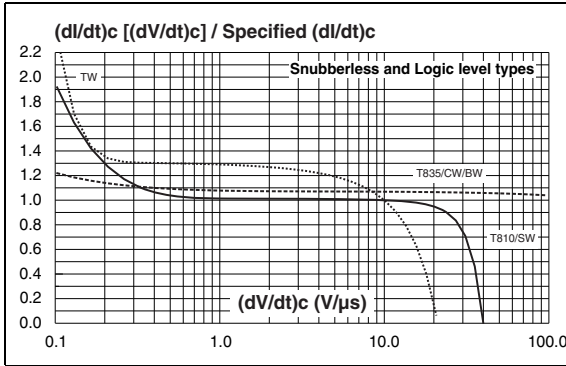


Figure 10. Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values)

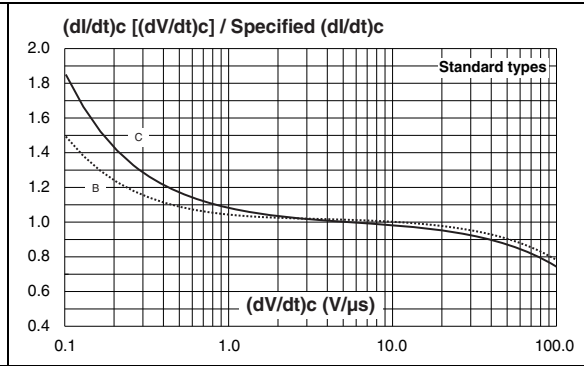


Figure 11. Relative variation of critical rate of decrease of main current versus junction temperature

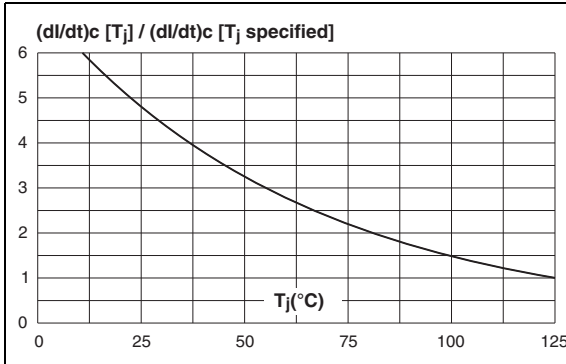
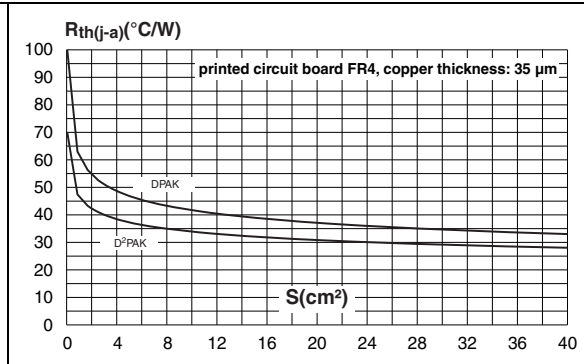


Figure 12. DPAK and D²PAK thermal resistance junction to ambient versus copper surface under tab



2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 6. D²PAK dimensions

| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 4.30 | | 4.60 | 0.169 | | 0.181 |
| A1 | 2.49 | | 2.69 | 0.098 | | 0.106 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.009 |
| B | 0.70 | | 0.93 | 0.027 | | 0.037 |
| B2 | 1.25 | 1.40 | | 0.048 | 0.055 | |
| C | 0.45 | | 0.60 | 0.017 | | 0.024 |
| C2 | 1.21 | | 1.36 | 0.047 | | 0.054 |
| D | 8.95 | | 9.35 | 0.352 | | 0.368 |
| E | 10.00 | | 10.28 | 0.393 | | 0.405 |
| G | 4.88 | | 5.28 | 0.192 | | 0.208 |
| L | 15.00 | | 15.85 | 0.590 | | 0.624 |
| L2 | 1.27 | | 1.40 | 0.050 | | 0.055 |
| L3 | 1.40 | | 1.75 | 0.055 | | 0.069 |
| R | 0.40 | | | 0.016 | | |
| V2 | 0° | | 8° | 0° | | 8° |

Figure 13. Footprint (dimensions in mm)

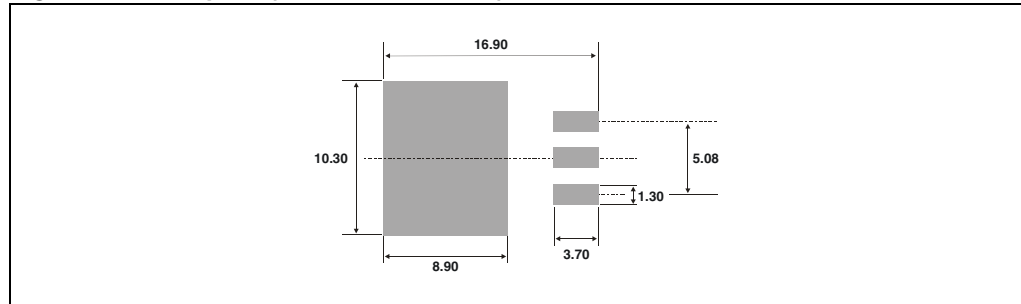


Table 7. DPAK dimensions

| Ref. | Dimensions | | | |
|------|-------------|-------|------------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 2.20 | 2.40 | 0.086 | 0.094 |
| A1 | 0.90 | 1.10 | 0.035 | 0.043 |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 |
| B | 0.64 | 0.90 | 0.025 | 0.035 |
| B2 | 5.20 | 5.40 | 0.204 | 0.212 |
| C | 0.45 | 0.60 | 0.017 | 0.023 |
| C2 | 0.48 | 0.60 | 0.018 | 0.023 |
| D | 6.00 | 6.20 | 0.236 | 0.244 |
| E | 6.40 | 6.60 | 0.251 | 0.259 |
| G | 4.40 | 4.60 | 0.173 | 0.181 |
| H | 9.35 | 10.10 | 0.368 | 0.397 |
| L2 | 0.80 typ. | | 0.031 typ. | |
| L4 | 0.60 | 1.00 | 0.023 | 0.039 |
| V2 | 0° | 8° | 0° | 8° |

Figure 14. Footprint (dimensions in mm)

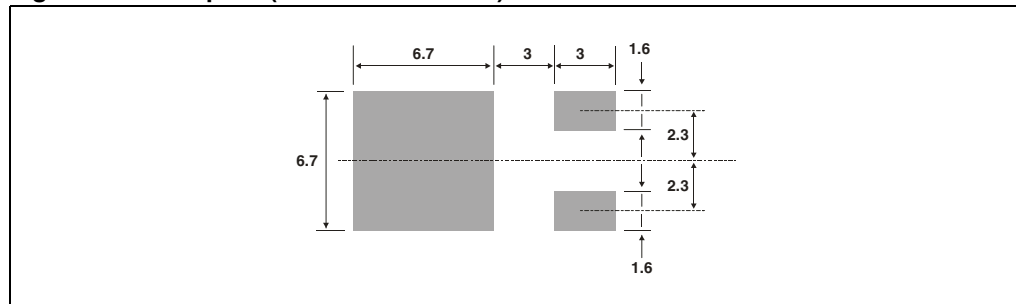
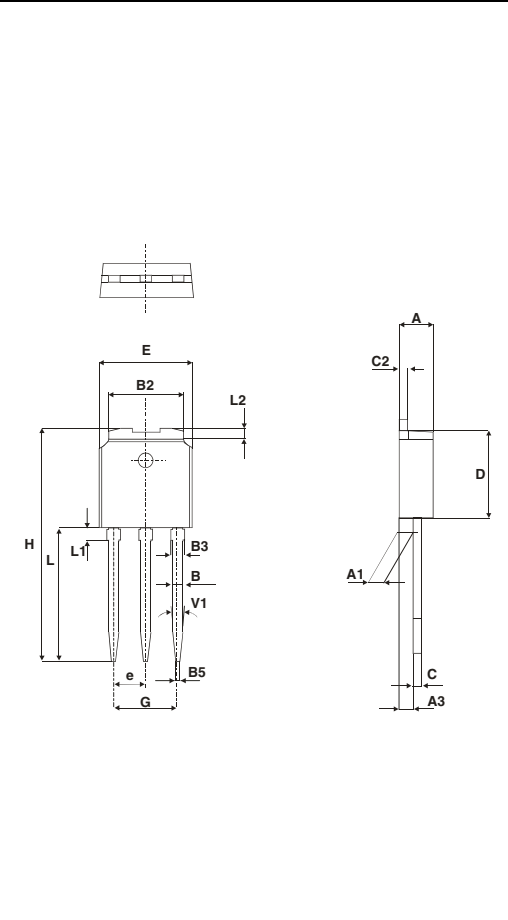


Table 8. IPAK dimensions



| Ref. | Dimensions | | | | | |
|------|-------------|-------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 | 0.086 | | 0.094 |
| A1 | 0.90 | | 1.10 | 0.035 | | 0.043 |
| A3 | 0.70 | | 1.30 | 0.027 | | 0.051 |
| B | 0.64 | | 0.90 | 0.025 | | 0.035 |
| B2 | 5.20 | | 5.40 | 0.204 | | 0.212 |
| B3 | | | 0.95 | | | 0.037 |
| B5 | | 0.30 | | | 0.035 | |
| C | 0.45 | | 0.60 | 0.017 | | 0.023 |
| C2 | 0.48 | | 0.60 | 0.019 | | 0.023 |
| D | 6 | | 6.20 | 0.236 | | 0.244 |
| E | 6.40 | | 6.60 | 0.252 | | 0.260 |
| e | | 2.28 | | | 0.090 | |
| G | 4.40 | | 4.60 | 0.173 | | 0.181 |
| H | | 16.10 | | | 0.634 | |
| L | 9 | | 9.40 | 0.354 | | 0.370 |
| L1 | 0.8 | | 1.20 | 0.031 | | 0.047 |
| L2 | | 0.80 | 1 | | 0.031 | 0.039 |
| V1 | | 10° | | | 10° | |

TO-220AB (Nlns. and Ins. 20-up) dimensions

| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 15.20 | | 15.90 | 0.598 | | 0.625 |
| a1 | | 3.75 | | | 0.147 | |
| a2 | 13.00 | | 14.00 | 0.511 | | 0.551 |
| B | 10.00 | | 10.40 | 0.393 | | 0.409 |
| b1 | 0.61 | | 0.88 | 0.024 | | 0.034 |
| b2 | 1.23 | | 1.32 | 0.048 | | 0.051 |
| C | 4.40 | | 4.60 | 0.173 | | 0.181 |
| c1 | 0.49 | | 0.70 | 0.019 | | 0.027 |
| c2 | 2.40 | | 2.72 | 0.094 | | 0.107 |
| e | 2.40 | | 2.70 | 0.094 | | 0.106 |
| F | 6.20 | | 6.60 | 0.244 | | 0.259 |
| Ø1 | 3.75 | | 3.85 | 0.147 | | 0.151 |
| I4 | 15.80 | 16.40 | 16.80 | 0.622 | 0.646 | 0.661 |
| L | 2.65 | | 2.95 | 0.104 | | 0.116 |
| I2 | 1.14 | | 1.70 | 0.044 | | 0.066 |
| I3 | 1.14 | | 1.70 | 0.044 | | 0.066 |
| M | | 2.60 | | | 0.102 | |

3 Ordering information

Figure 15. Ordering information scheme (BTA08 and BTB08 series)

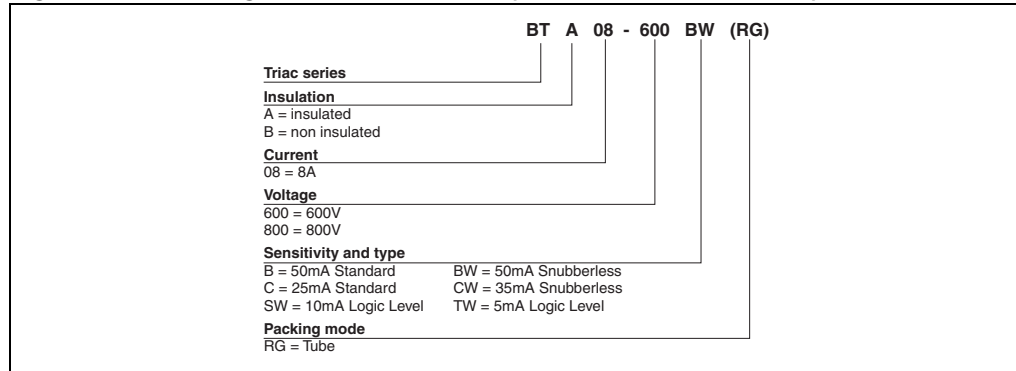


Figure 16. Ordering information scheme (T8 series)

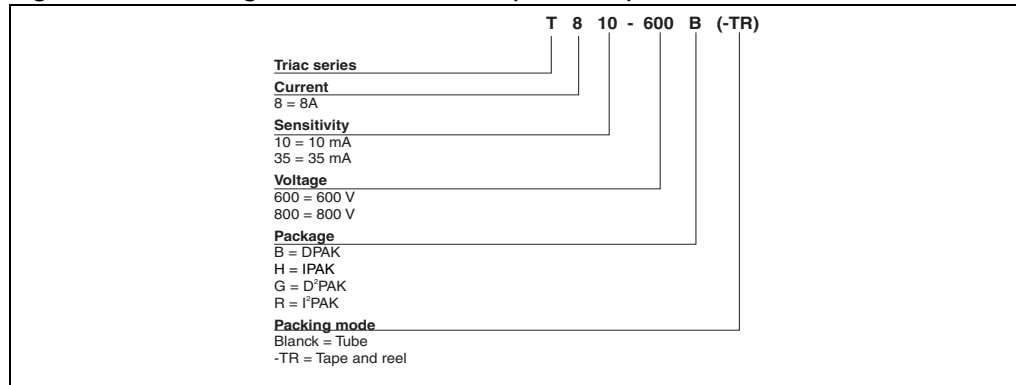


Table 9. Product Selector

| Part Number | Voltage (xxx) | | Sensitivity | Type | Package |
|-----------------|---------------|-------|-------------|-------------|--------------------|
| | 600 V | 800 V | | | |
| BTA/BTB08-xxxB | X | X | 50 mA | Standard | TO-220AB |
| BTA/BTB08-xxxBW | X | X | 50 mA | Snubberless | TO-220AB |
| BTA/BTB08-xxxC | X | X | 25 mA | Standard | TO-220AB |
| BTA/BTB08-xxxCW | X | X | 35 mA | Snubberless | TO-220AB |
| BTA/BTB08-xxxSW | X | X | 10 mA | Logic level | TO-220AB |
| BTA/BTB08-xxxTW | X | X | 5 mA | Logic Level | TO-220AB |
| T810-xxxG | X | X | 10 mA | Logic Level | D ² PAK |
| T810-xxxH | X | X | 10 mA | Logic Level | IPAK |
| T835-xxxB | X | X | 35 mA | Snubberless | DPAK |
| T835-xxxG | X | X | 35 mA | Snubberless | D ² PAK |
| T835-xxxH | X | X | 35 mA | Snubberless | IPAK |

BTB: non insulated TO-220AB package

4 Ordering information

Table 10. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|--------------------|------------------|--------------------|--------|----------|---------------|
| BTA/BTB08-xxxzyzRG | BTA/BTB08-xxxzyz | TO-220AB | 2.3 g | 50 | Tube |
| T8yy-xxxG | T8yyxx | D ² PAK | 1.5 g | 50 | Tube |
| T8yy-xxxG-TR | T8yyxx | | | 1000 | Tape and reel |
| T8yy-xxxB | T8yyxx | DPAK | 0.3 g | 75 | Tube |
| T8yy-xxxB-TR | T8yyxx | | | 2500 | Tape and reel |
| T8yy-xxxH | T8yyxx | IPAK | 0.4 g | 75 | Tube |

xxx = voltage, yy = sensitivity, z = type

5 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| Apr-2002 | 5A | Last update. |
| 13-Feb-2006 | 6 | TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added. |
| 10-Mar-2010 | 7 | Updated ECOPACK statement and Figure 16 . |

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